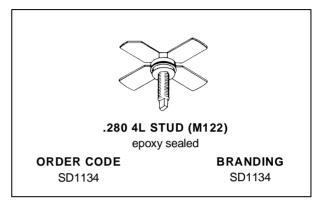


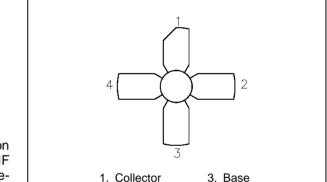
SD1134

RF & MICROWAVE TRANSISTORS UHF MOBILE APPLICATIONS

- 450 512 MHz
- 12.5 VOLTS
- EFFICIENCY 55%
- COMMON EMITTER
- Pout = 2.0 W MIN. WITH 10.0 dB GAIN



PIN CONNECTION



4. Emitter

2. Emitter

DESCRIPTION

The SD1134 is a 12.5 V Class C epitaxial silicon NPN planar transistor designed primarily for UHF communications. This device utilizes improved metallization to achieve infinite VSWR at rated operating conditions.

ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	36	V
VCEO	Collector-Emitter Voltage	16	V
Vces	Collector-Emitter Voltage	36	V
V _{EBO}	Emitter-Base Voltage	4.0	V
Ic	Device Current	0.75	А
P _{DISS}	Power Dissipation	5	W
TJ	Junction Temperature	+200	°C
T _{STG}	Storage Temperature	- 65 to +150	°C

THERMAL DATA

R _{TH(j-c)} Junction-Case Thermal Resistance	35	°C/W
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November 1992 1/4

ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)

STATIC

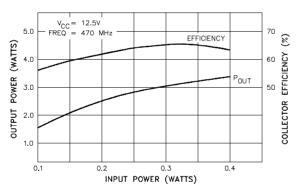
Symbol	Test Conditions		Value			Unit	
Symbol	yindoi rest conditions		I	Min.	Тур.	Max.	Unit
BVces	I _C = 5mA	$V_{BE} = 0V$		36			V
BVceo	I _C = 25mA	$I_B = 0mA$		16	_	_	V
BV _{EBO}	I _E = 1mA	$I_C = 0mA$		4.0	_	_	V
I _{CBO}	$V_{CB} = 15V$	$I_{E} = 0mA$		_		1	mA
h _{FE}	V _{CE} = 5V	$I_C = 100 \text{mA}$		20	_	_	_

DYNAMIC

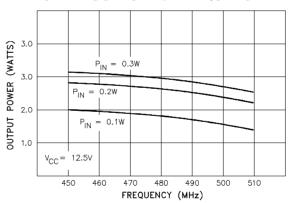
Symbol	Test Conditions				Value		Unit
Symbol		rest Conditions			Тур.	Max.	Oiiit
Pout	f = 470 MHz	$P_{IN} = 0.20 W$	$V_{CC} = 12.5 \text{ V}$	2.0	_	_	W
G _P	f = 470 MHz	$P_{IN} = 0.20 W$	$V_{CC} = 12.5 \text{ V}$	10.0	_	_	dB
Сов	f = 1 MHz	V _{CB} = 12 V		_	6	_	pF

TYPICAL PERFORMANCE

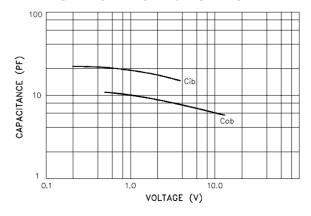
POWER OUTPUT & COLLECTOR EFFICIENCY vs POWER INPUT



POWER OUTPUT vs FREQUENCY

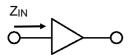


CAPACITANCE vs VOLTAGE

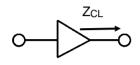


IMPEDANCE DATA



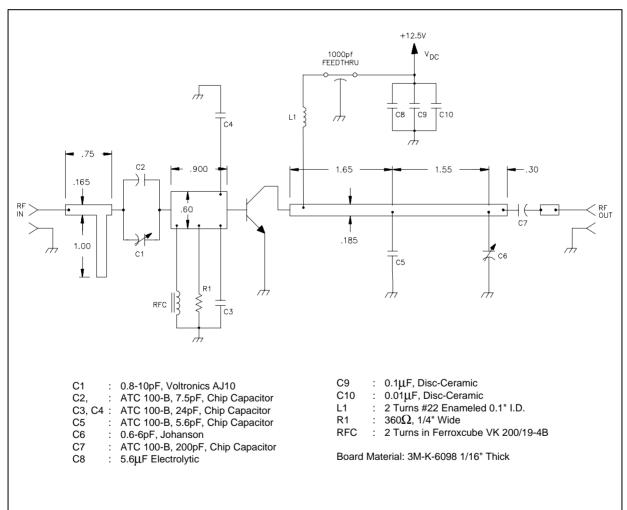


TYPICAL COLLECTOR LOAD IMPEDANCE



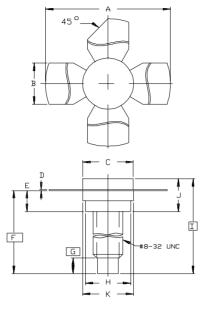
FREQ.	Z _{IN} (Ω)	Z _{CL} (Ω)		
450 MHz	2.7 + j 0.9	11.5 – j 15.0		
470 MHz	2.6 + j 1.3	12.2 – j 13.5		
512 MHz	2.2 + j 1.7	12.7 – j 13.0		

TEST CIRCUIT



PACKAGE MECHANICAL DATA

Ref.: Dwg. No.12-0122



SG	SGS-THOMSON MICROELECTRONICS				
	MINIMUM	MAXIMUM			
	Inches/mm	Inches/mm			
Α	1.010/25,65	1.055/26,80			
В	.220/5,59	.230/5,84			
С	.270/6,86 .285/7,24				
D	.003/0,08	.007/0,18			
E	.117/2,97	.137/3,48			
F	.572/14,53				
G	.130/3,30				
Н	.245/6,22	.255/6,48			
I	.640/16,26				
J	.175/4,45	.217/5,51			
К	.275/6,99	.285/7,24			

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